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ZSF200X-A

Category:	
Generic Part:	ZSF200X
Market Group:	SSP
Description:	SWITCH FABRIC



Parameters

Package	FCBGA 241 (BL1241)
Speed	NA
Temperature	C
Voltage	5.0 V
Status	Active
Sample	Yes
Minimum Order Quantity	1
Factory Order Increment	1

Distributor Inventory

No Pricing information is available from our Distributors at this time.

Documents

No documents available for this part at this time.

Package

Description	FLIP CHIP BGA 40.0 X 40.0 MM X 1.0 MM PI
Class	PLASTIC
Moisture Sensitivity Level (MSL)	4
Category	Standard
Moisture Exposure Floor Life	72 hrs. @ <30°C/60%RH
Peak Reflow Temperature	225°C
Rebake Conditions	48 hrs.@125°C
Length	40.0
Mark	\
Width	40.0
Pitch	1.0
Thickness	2.82
Status	Active

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